



In the United States Patent and Trademark Office

Serial Number: 10/760246
Application. Filed: January 21, 2004
Applicant: Kia Silverbrook; Norman Micheal Berry; Garry Raymond Jackson; Akira Nakazawa
Application Title: Printhead Assembly with Interconnected Printhead Modules
Examiner/GAU: Laura E Martin 2853
Dated December 7, 2006
At: Balmain, NSW
Docket No. MPA10US

REPLY

Commissioner for Patents
Washington, District of Columbia 20231

Dear Sir:

In response to the Advisory Action of November 27, 2006, Applicant encloses a Request for Continuing Examination together with the prescribed fee.

The supporting submissions are set out below.

Applicant submits that the enclosed RCE fully complies with 37 CFR 1.114 and therefore asks that the finality of the last report be withdrawn and the submissions of May 11, 2004 be fully considered.

SUBMISSIONS

35 U.S.C. §102 - Claims 1 and 5

Claims 1 and 5 stand rejected for lack of novelty in light of US 6,439,908 to Silverbrook.

Claim 1 requires that the printhead integrated circuits (IC's) are **fixably** mounted to the support member. The Examiner has read the molding 32 of '908 onto the support member of the present invention. However, the '908 disclosure is primarily directed to an assembly where the printhead modules 12 (and therefore the printhead IC's 18) are removable and replaceable. In the present invention the printhead IC's on each module are all fixedly mounted to a single support member.